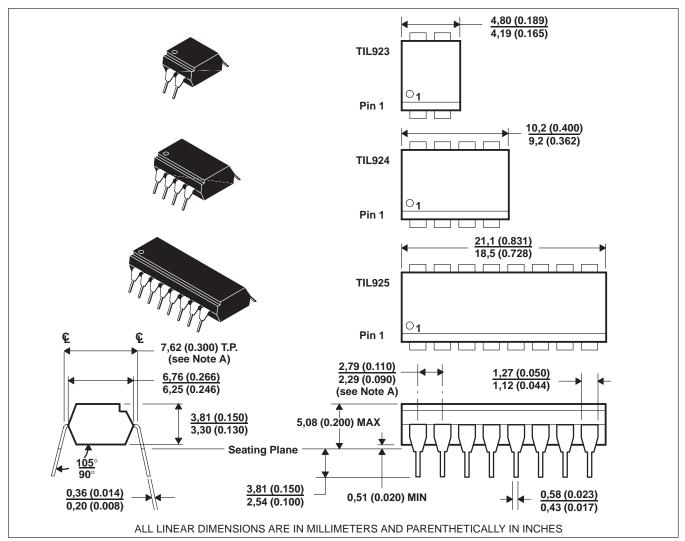
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- Gallium-Arsenide Diode Infrared Source
- Source Is Optically Coupled to Silicon N-P-N Darlington Phototransistor
- Choice of One, Two, or Four Channels
- Choice of Two Current-Transfer Ratios
- High-Voltage Electrical Isolation . . . 7.5 kV Peak (5.3 kV rms)
- Plastic Dual-In-Line Packages
- UL Listed File No. E65085

#### description

These optocouplers consist of a gallium-arsenide light-emitting diode and a silicon n-p-n Darlington phototransistor per channel. The TIL923 has one channel in a 4-pin package, the TIL924 has two channels in a 8-pin package, and the TIL925 has four channels in a 16-pin package. The standard devices, TIL923, TIL924, and TIL925, are tested for a current-transfer ratio of 500% minimum. Devices selected for a current-transfer ratio of 1000% are designated with the suffix.

#### mechanical data



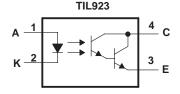
NOTE A: Each pin centerline is located 0,25 (0.010) of its true longitudinal position.

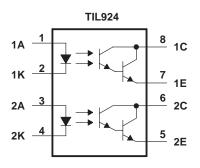


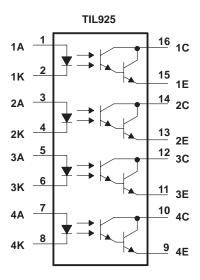
# SINGLE/DUAL/QUAD CHANNEL OPTOCOUPLERS/OPTOISOLATORS

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# schematic diagrams







### absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

Input-to-output voltage (see Note 1)±7.5 kV peak	k or dc (±5.3 kV rms)
Collector-emitter voltage (see Note 2)	
Emitter-collector voltage	7 V
Input diode reverse voltage	5 V
Input diode continuous forward current at (or below) 25°C free-air temperature (see Note	e 3) 50 mA
Continuous power dissipation at (or below) 25°C free-air temperature:	
Phototransistor (see Note 4)	150 mW
Input diode plus phototransistor per channel (see Note 5)	200 mW
Operating free-air temperature, T <sub>A</sub>	−55°C to 100°C
Storage temperature range	−55°C to 125°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

- NOTES: 1. This rating applies for sine-wave operation at 50 or 60 Hz. Service capability is verified by testing in accordance with UL requirements.
  - 2. This value applies when the base-emitter diode is open circuited.
  - 3. Derate linearly to 100°C free-air temperature at the rate of 0.67 mA/°C.
  - 4. Derate linearly to 100°C free-air temperature at the rate of 2 mW/°C.
  - 5. Derate linearly to 100°C free-air temperature at the rate of 2.67 mW/°C.

# electrical characteristics, T<sub>A</sub> = 25°C (unless otherwise noted)

PARAMETER			TEST	MIN	TYP	MAX	UNIT		
V(BR)CEO	Collector-emitter breakdown voltage		$I_C = 0.5 \text{ mA}, \qquad I_F = 0$			35			V
V(BR)ECO	Emitter-collector breakdown voltage		I <sub>C</sub> = 100 μA,	IF = 0		7			V
I <sub>R</sub>	Input diode static reverse current		V <sub>R</sub> = 5 V					10	μΑ
IC(off)	Off-state collector current		V <sub>CE</sub> = 10 V,	IF = 0				100	nA
CTR	Current transfer ratio	TIL923, TIL924, TIL925	I <sub>F</sub> = 2 mA,	V <sub>CE</sub> = 1 V		500%			
		TIL923A, TIL924A, TIL925A				1000%			
٧F	Input diode static forward voltage		I <sub>F</sub> = 20 mA					1.4	V
VCE(sat)	Collector-emitter saturation voltage		I <sub>F</sub> = 10 mA,	$I_C = 50 \text{ mA}$				1	V
C <sub>io</sub>	Input-to-output capacitance		$V_{in-out} = 0$ ,	f = 1 MHz,	See Note 6		1		pF
r <sub>io</sub>	Input-to-output internal resistance		$V_{in-out} = \pm 1 \text{ kV},$	See Note 6			1011		Ω

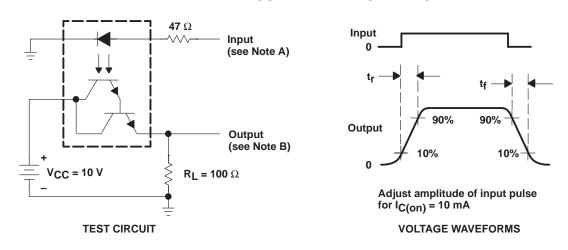
NOTE 6. These parameters are measured between all input-diode leads shorted together and all phototransistor leads shorted together.



## switching characteristics at 25°C free-air temperature

	PARAMETER	TEST CONDITIONS				TYP	MAX	UNIT
t <sub>r</sub>	Rise time	V <sub>CC</sub> = 10 V,	lar > = 10 mA	See Figure 1	100			
tf	Fall time		$I_{C(on)} = 10 \text{ mA}, R_L = 100 \Omega,$			100		μs

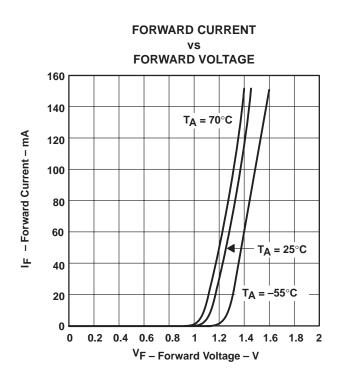
#### PARAMETER MEASUREMENT INFORMATION

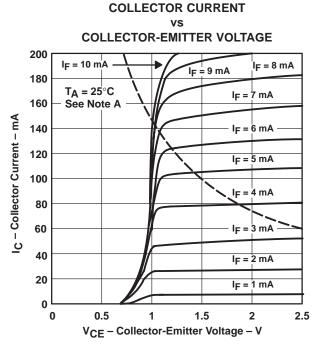


NOTES: A. The input waveform is supplied by a generator with the following characteristics:  $Z_0 = 50 \,\Omega$ ,  $t_r \le 15 \,\text{ns}$ , duty cycle = 1%,  $t_W = 500 \,\mu\text{s}$ . B. The output waveform is monitored on an oscilloscope with the following characteristics:  $t_r \le 12 \,\text{ns}$ ,  $R_{in} \ge 1 \,\text{M}\Omega$ ,  $C_{in} \le 20 \,\text{pF}$ .

Figure 1. Switching Times

#### TYPICAL CHARACTERISTICS





NOTE A: Pulse operation is required for operation beyond limits shown by the dashed line.

Figure 2 Figure 3

# **COLLECTOR CURRENT** INPUT DIODE FORWARD CURRENT 1000 V<sub>CE</sub> = 1 V 400 $T_A = 25^{\circ}C$ See Note A I<sub>C</sub> - Collector Current - mA 100 40 10 0.4 0.1 100 0.1 0.4 IF - Forward Current - mA

NOTE A: These parameters are measured using pulse techniques  $t_W=1 \ \text{ms, duty cycle} \leq 2\%.$ 

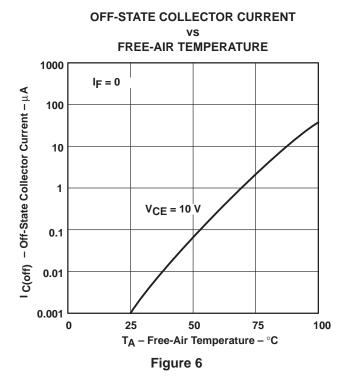
Figure 4



#### **TYPICAL CHARACTERISTICS**

# **RELATIVE ON-STATE COLLECTOR CURRENT** FREE-AIR TEMPERATURE 1.2 Collector Current Relative to Value at TA = 25 $^{\circ}\text{C}$ V<sub>CE</sub> = 1 V I<sub>F</sub> = 10 mA IF = 2 mA 0.8 I<sub>F</sub> = 10 mA 0.6 0.4 I<sub>F</sub> = 2 mA 0.2 -75 -50 -25 25 75 100 $T_A$ – Free-Air Temperature – $^{\circ}C$

Figure 5



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